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November 2009

## FAN7371 High-Current High-Side Gate Drive IC

#### **Features**

- Floating Channel for Bootstrap Operation to +600V
- 4A/4A Sourcing/Sinking Current Driving Capability
- Common-Mode dv/dt Noise Canceling Circuit
- 3.3V and 5V Input Logic Compatible
- Output In-phase with Input Signal
- Under- Voltage Lockout for V<sub>BS</sub>
- 25V Shunt Regulator on V<sub>DD</sub> and V<sub>BS</sub>
- 8-Lead Small Outline Package (SOP)

### **Applications**

- High-Speed Gate Driver
- Sustaine Switch Driver in PDP Application
- Energy-Recovery Circuit Switch Driver in PDP Application
- High-Power Buck Converter
- Motor Drive Inverter

### Description

The FAN7371 is a monolithic high-side gate drive IC, which can drive high-speed MOSFETs and IGBTs that operate up to +600V. It has a buffered output stage with all NMOS transistors designed for high pulse current driving capability and minimum cross-conduction.

Fairchild's high-voltage process and common-mode noise canceling techniques provide stable operation of the high-side driver under high dv/dt noise circumstances. An advanced level-shift circuit offers high-side gate driver operation up to  $V_S$ =-9.8V (typical) for  $V_{BS}$ =15V.

The UVLO circuit prevents malfunction when  $V_{BS}$  is lower than the specified threshold voltage.

The high-current and low-output voltage drop feature makes this device suitable for sustaine switch driver and energy recovery switch driver in the Plasma Display Panel application, motor drive inverter, switching power supply, and high-power DC-DC converter applications.

8-SOP



### **Ordering Information**

Part Number	Package	Operating Temperature Range	© Eco Status	Packing Method	
FAN7371M <sup>(1)</sup>	8-SOP	-40°C ~ 125°C	RoHS	Tube	
FAN7371MX <sup>(1)</sup>	0-3UP	-40 C ~ 125 C	RUHS	Tape & Reel	

#### Note:

1. These devices passed wave soldering test by JESD22A-111.



For Fairchild's definition of Eco Status, please visit: <a href="http://www.fairchildsemi.com/company/green/rohs\_green.html">http://www.fairchildsemi.com/company/green/rohs\_green.html</a>.

### **Typical Application Diagrams**

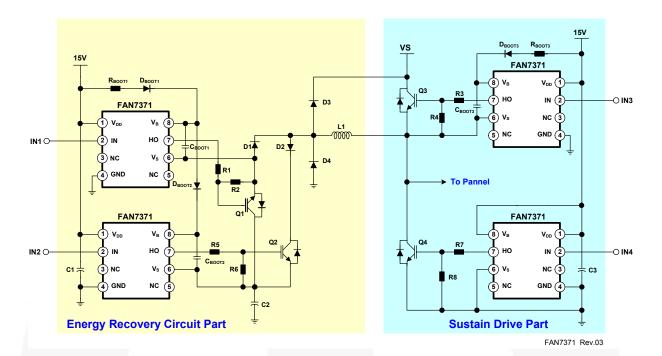


Figure 1. Floated Bidirectional Switch and Half-Bridge Driver: PDP application

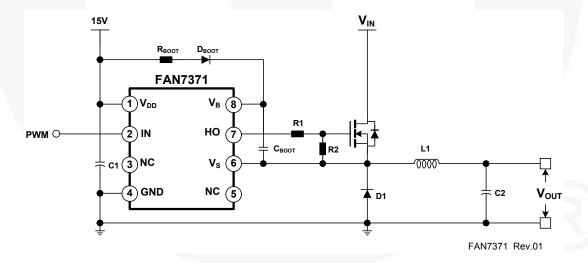
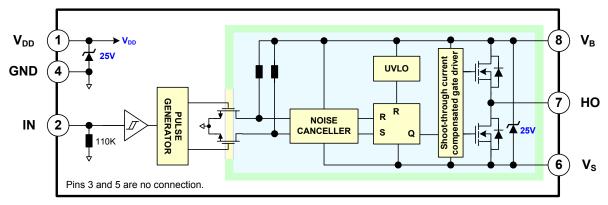


Figure 2. Step-Down (Buck) DC-DC Converter Application

### **Internal Block Diagram**



FAN7371 Rev.04

Figure 3. Functional Block Diagram

### **Pin Configuration**

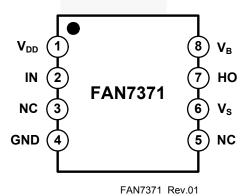


Figure 4. Pin Configuration (Top View)

### **Pin Definitions**

Pin #	Name	Description	
1	V <sub>DD</sub>	Supply Voltage	
2	IN	Logic Input for High-Side Gate Driver Output	
3	NC	No Connection	
4	GND	Ground	
5	NC	No Connection	
6	V <sub>S</sub>	High-Voltage Floating Supply Return	
7	НО	High-Side Driver Output	
8	V <sub>B</sub>	High-Side Floating Supply	

### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.  $T_A=25^{\circ}C$  unless otherwise specified.

Symbol	Characteristics	Min.	Max.	Unit
V <sub>S</sub>	High-Side Floating Offset Voltage	V <sub>B</sub> -V <sub>SHUNT</sub>	V <sub>B</sub> +0.3	V
V <sub>B</sub>	High-Side Floating Supply Voltage <sup>(2)</sup>	-0.3	625.0	V
V <sub>HO</sub>	High-Side Floating Output Voltage	V <sub>S</sub> -0.3	V <sub>B</sub> +0.3	V
V <sub>DD</sub>	Low-Side and Logic Supply Voltage <sup>(2)</sup>	-0.3	V <sub>SHUNT</sub>	V
V <sub>IN</sub>	V <sub>IN</sub> Logic Input Voltage		V <sub>DD</sub> +0.3	V
dV <sub>S</sub> /dt	Allowable Offset Voltage Slew Rate		± 50	V/ns
P <sub>D</sub> Power Dissipation <sup>(3, 4, 5)</sup>		100	0.625	W
$\theta_{JA}$	Thermal Resistance		200	°C/W
TJ	Junction Temperature	-55	+150	°C
T <sub>STG</sub>	Storage Temperature	-55	+150	°C
T <sub>A</sub>	Operating Ambient Temperature	-40	+125	°C

#### Notes:

- 2 This IC contains a shunt regulator on V<sub>DD</sub> and V<sub>BS</sub> with a normal breakdown voltage of 25V. Please note that this supply pin should not be driven by a low-impedance voltage source greater than the V<sub>SHUNT</sub> specified in the Electrical Characteristics section
- 3 Mounted on 76.2 x 114.3 x 1.6mm PCB (FR-4 glass epoxy material).
- 4 Refer to the following standards:
  JESD51-2: Integral circuits thermal test method environmental conditions, natural convection, and
  JESD51-3: Low effective thermal conductivity test board for leaded surface mount packages.
- 5 Do not exceed power dissipation (P<sub>D</sub>) under any circumstances.

### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Symbol Parameter		Max.	Unit
V <sub>BS</sub>	High-Side Floating Supply Voltage	V <sub>S</sub> +10	V <sub>S</sub> +20	V
V <sub>S</sub>	High-Side Floating Supply Offset Voltage	6-V <sub>DD</sub>	600	V
V <sub>HO</sub>	V <sub>HO</sub> High-Side Output Voltage		V <sub>B</sub>	V
V <sub>IN</sub>	Logic Input Voltage	GND	$V_{DD}$	V
$V_{DD}$	Supply Voltage	10	20	V

#### **Electrical Characteristics**

 $V_{BIAS}(V_{DD}, V_{BS})$ =15.0V,  $T_A$  = 25°C, unless otherwise specified. The  $V_{IN}$  and  $I_{IN}$  parameters are referenced to GND. The  $V_O$  and  $I_O$  parameters are relative to  $V_S$  and are applicable to the respective output HO.

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
POWER S	SUPPLY SECTION	1		l		ı
$I_{QDD}$	Quiescent V <sub>DD</sub> Supply Current	V <sub>IN</sub> =0V or 5V		25	70	μА
$I_{PDD}$	Operating V <sub>DD</sub> Supply Current	f <sub>IN</sub> =20KHz, No Load		35	100	μΑ
BOOTS1	RAPPED SUPPLY SECTION			ı		ı
V <sub>BSUV+</sub>	V <sub>BS</sub> Supply Under-Voltage Positive Going Threshold Voltage	V <sub>BS</sub> =Sweep	8.2	9.2	10.2	V
V <sub>BSUV</sub> -	V <sub>BS</sub> Supply Under-Voltage Negative Going Threshold Voltage	V <sub>BS</sub> =Sweep	7.5	8.5	9.5	V
V <sub>BSHYS</sub>	V <sub>BS</sub> Supply Under-Voltage Lockout Hysteresis Voltage	V <sub>BS</sub> =Sweep		0.7		V
I <sub>LK</sub>	Offset Supply Leakage Current	V <sub>B</sub> =V <sub>S</sub> =600V			10	μΑ
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> Supply Current	V <sub>IN</sub> =0V or 5V		60	120	μΑ
I <sub>PBS</sub>	Operating V <sub>BS</sub> Supply Current	C <sub>LOAD</sub> =1nF, f <sub>IN</sub> =20KHz, rms Value		1.0	2.8	mA
SHUNT R	EGULATOR SECTION		1	l		l
V <sub>SHUNT</sub>	V <sub>DD</sub> and V <sub>BS</sub> Shunt Regulator Clamping Voltage	I <sub>SHUNT</sub> =5mA	24	25		V
INPUT LO	OGIC SECTION			l.		
$V_{IH}$	Logic "1" Input Voltage		2.5			V
$V_{IL}$	Logic "0" Input Voltage				0.8	V
I <sub>IN+</sub>	Logic Input High Bias Current	V <sub>IN</sub> =5V		45	70	μΑ
I <sub>IN-</sub>	Logic Input Low Bias Current	V <sub>IN</sub> =0V			2	μΑ
$R_{IN}$	Input Pull-down Resistance		70	110		ΚΩ
GATE DR	IVER OUTPUT SECTION					
V <sub>OH</sub>	High Level Output Voltage (V <sub>BIAS</sub> - V <sub>O</sub> )	No Load			1.2	V
V <sub>OL</sub>	Low Level Output Voltage	No Load	7		30	mV
I <sub>O+</sub>	Output High, Short-Circuit Pulsed Current <sup>(6)</sup>	V <sub>HO</sub> =0V, V <sub>IN</sub> =5V, PW ≤10μs	3.0	4.0		Α
I <sub>O-</sub>	Output Low, Short-Circuit Pulsed Current <sup>(6)</sup>	V <sub>HO</sub> =15V,V <sub>IN</sub> =0V, PW ≤10μs	3.0	4.0		Α
V <sub>S</sub>	Allowable Negative V <sub>S</sub> pin Voltage for IN Signal Propagation to HO			-9.8	-7.0	V

#### Note:

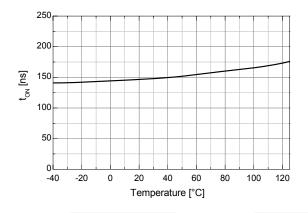
6 These parameters guaranteed by design.

### **Dynamic Electrical Characteristics**

 $V_{DD}$ = $V_{BS}$ =15V, GND=0V,  $C_{LOAD}$ =1000pF,  $T_A$ =25°C, unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
t <sub>on</sub>	Turn-on Propagation Delay Time	V <sub>S</sub> =0V		150	210	ns
t <sub>off</sub> Turn-off Propagation Delay Time		V <sub>S</sub> =0V		150	210	ns
t <sub>r</sub> Turn-on Rise Time				25	50	ns
t <sub>f</sub>	Turn-off Fall Time			15	40	ns

### **Typical Characteristics**



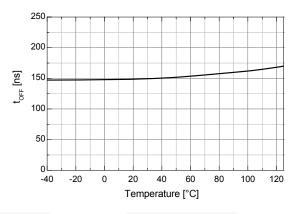
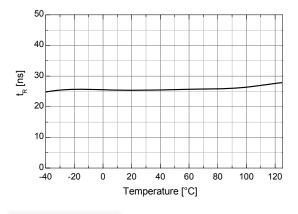


Figure 5. Turn-on Propagation Delay vs. Temperature

Figure 6. Turn-off Propagation Delay vs. Temperature



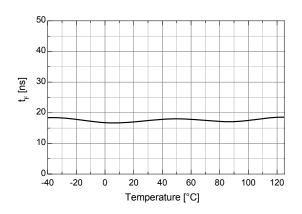


Figure 7. Turn-on Rise Time vs. Temperature

Figure 8. Turn-off Fall Time vs. Temperature

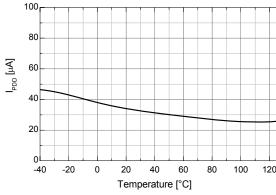


Figure 9. Operating V<sub>DD</sub> Supply Current

vs. Temperature

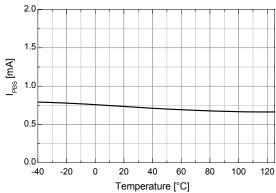
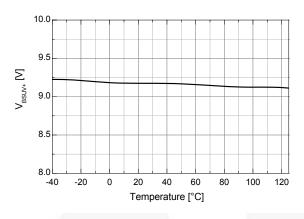


Figure 10. Operating V<sub>BS</sub> Supply Current vs. Temperature

### Typical Characteristics (Continued)



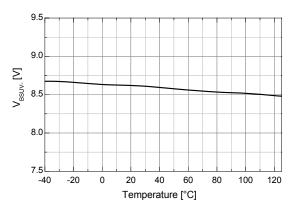
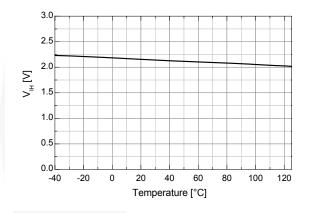


Figure 11. V<sub>BS</sub> UVLO+ vs. Temperature

Figure 12. V<sub>BS</sub> UVLO- vs. Temperature



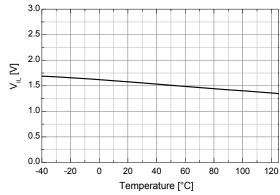


Figure 13. Logic High Input Voltage vs. Temperature

Figure 14. Logic Low Input Voltage vs. Temperature

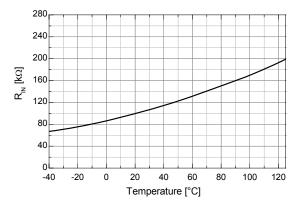


Figure 15. Input Pull-Down Resistance vs.Temperature.

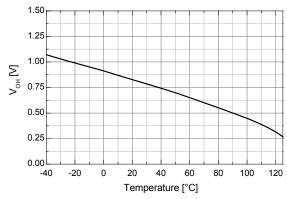
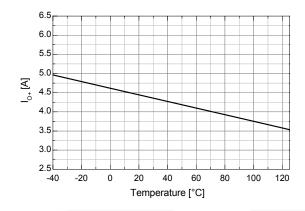


Figure 16. High-Level Output Voltage vs. Temperature

### **Typical Characteristics** (Continued)



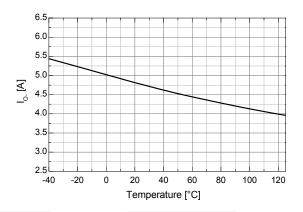
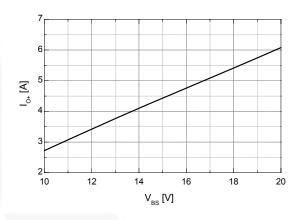


Figure 17. Output High, Short-Circuit Pulsed Current vs. Temperature

Figure 18. Output Low, Short-Circuit Pulsed Current vs. Temperature



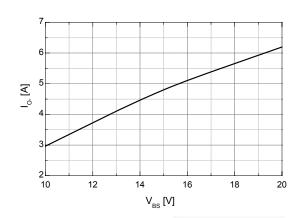
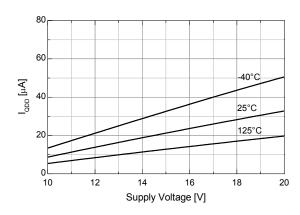


Figure 19. Output High, Short-Circuit Pulsed Current vs. Supply Voltage

Figure 20. Output Low, Short-Circuit Pulsed Current vs. Supply Voltage



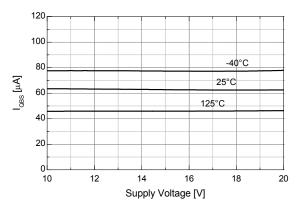


Figure 21. Quiescent V<sub>DD</sub> Supply Current vs. Supply Voltage

Figure 22. Quiescent V<sub>BS</sub> Supply Current vs. Supply Voltage

### **Switching Time Definitions**

### **Timing Diagram**

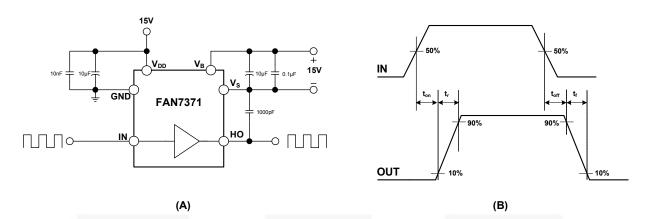


Figure 23. Switching Time Test Circuit and Waveform Definitions

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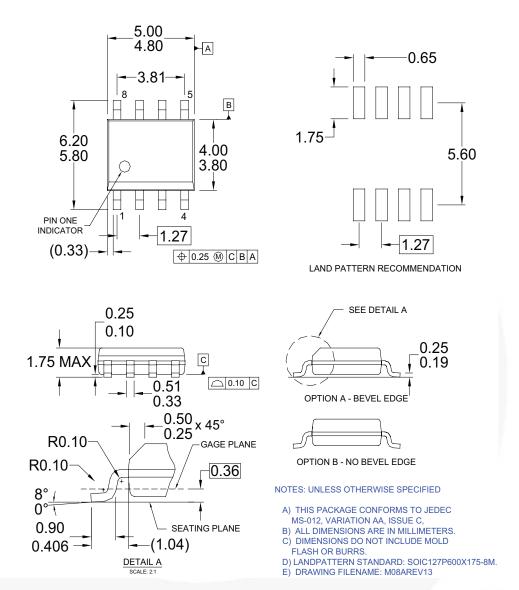


Figure 24. 8-Lead Small Outline Package (SOP)

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89076GBEST 00053P0231 56956 57.404.7355.5 LT4936 57.904.0755.0 5882900001 00600P0005 00-9050-LRPP 00-9090-RDPP
5951900000 01-1003W-10/32-15 0131700000 00-2240 LTP70N06 LVP640 5J0-1000LG-SIL LY1D-2-5S-AC120 LY2-US-AC240 LY3UA-DC24 00576P0020 00600P0010 LZN4-UA-DC12 LZNQ2M-US-DC5 LZNQ2-US-DC12 LZP40N10 00-8196-RDPP 00-8274-RDPP
00-8275-RDNP 00-8722-RDPP 00-8728-WHPP 00-8869-RDPP 00-9051-RDPP 00-9091-LRPP 00-9291-RDPP 0207100000 0207400000
01312 0134220000 60713816 M15730061 61161-90 61278-0020 6131-204-23149P 6131-205-17149P 6131-209-15149P 6131-218-17149P
6131-220-21149P 6131-260-2358P 6131-265-11149P